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# MOS FIELD EFFECT POWER TRANSISTOR 2SK1283

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK1283 is N-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

#### **FEATURES**

Low On-state Resistance

RDS(on)  $\leq$  0.18  $\Omega$  (VGS = 10 V, ID = 2 A) RDS(on)  $\leq$  0.24  $\Omega$  (VGS = 4 V, ID = 2 A)

- Low Ciss Ciss = 500 pF TYP.
- Built-in G-S Gate Protection Diode

#### **QUALITY GRADE**

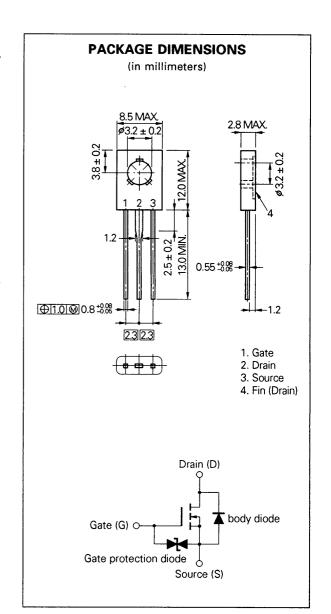
#### Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

#### ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

$ \begin{array}{llllllllllllllllllllllllllllllllllll$	Drain to Source Voltage	Voss	60	V
$\begin{array}{llllllllllllllllllllllllllllllllllll$	Gate to Source Voltage	Vgss(ac)	±20	V
Total Power Dissipation ( $Tc = 25  ^{\circ}C$ ) PT1 20 W Total Power Dissipation ( $T_a = 25  ^{\circ}C$ ) PT2 1.3 W Channel Temperature $T_{ch}$ 150 °C	Drain Current (DC)	ID(DC)	±3.0	Α
Total Power Dissipation ( $T_a = 25$ °C) PT2 1.3 W Channel Temperature T <sub>ch</sub> 150 °C	Drain Current (pulse)	D(pulse)*	±12	Α
Channel Temperature T <sub>ch</sub> 150 °C	Total Power Dissipation (Tc = 25 °C)	PT1	20	W
	Total Power Dissipation (T <sub>a</sub> = 25 °C)	PT2	1.3	W
Storage Temperature T <sub>stg</sub> -55 to +150 °C	Channel Temperature	Tch	150	°C
	Storage Temperature	Tstg	-55 to +150	°C

<sup>\*</sup> PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %

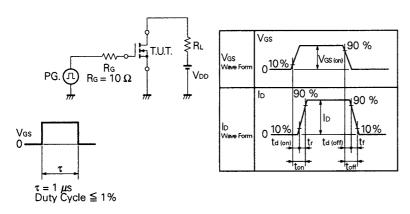




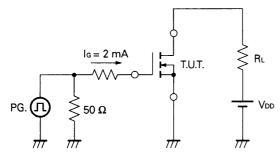
### ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	RDS(on)		0.15	0.18	Ω	Vgs = 10 V, ID = 2 A
Drain to Source On-state Resistance	RDS(on)		0.18	0.24	Ω	Vgs = 4.0 V, lp = 2 A
Gate to Source Cutoff Voltage	VGS(off)	1.0		2.5	٧	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	y fs	2.4			S	Vps = 10 V, lp = 2 A
Drain Leakage Current	Ipss			10	μА	Vps = 60 V, Vgs = 0
Gate to Source Leakage Current	Igss			±10	μΑ	Vgs = ± 20 V, Vps = 0
Input Capacitance	Ciss		500		pF	V <sub>DS</sub> = 10 V
Output Capacitance	Coss		200		pF	Vgs = 0 f = 1 MHz
Reverse Transfer Capacitance	Crss		40		pF	
Turn-On Delay Time	td(on)		40		ns	$V_{GS(on)} = 10 \text{ V}$ $V_{DD} = 30 \text{ V}$ $I_D = 2 \text{ A, Rg} = 10 \Omega$ $R_L = 15 \Omega$
Rise Time	tr		100		ns	
Turn-Off Delay Time	td(off)		550		ns	
Fall Time	tr		200		ns	
Total Gate Charge	Qg		13		nC	V <sub>GS</sub> = 10 V I <sub>D</sub> = 3 A V <sub>DD</sub> = 48 V
Gate to Source Charge	Qgs		3		nC	
Gate to Drain Charge	QgD		3		nC	
Diode Forward Voltage	VsD		0.9		V	IsD = 3 A, Vgs = 0
Reverse Recovery Time	trr		140		ns	lr = 3 A, Vσs = 0 di/dt = 50 A/μs
Reverse Recovery Charge	Qrr		700		nC	

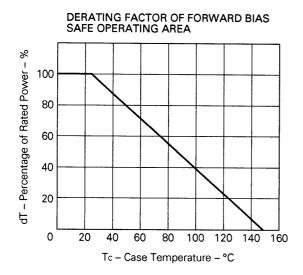
## **Test Circuit 1: Switching Time**

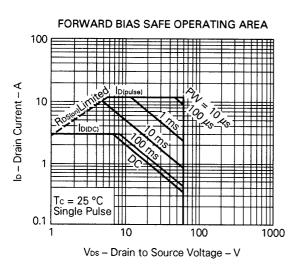


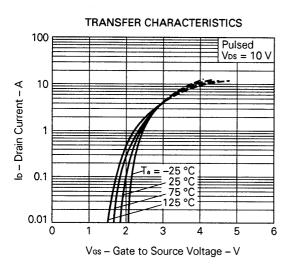
## **Test Circuit 2: Gate Charge**

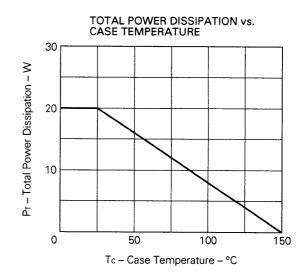


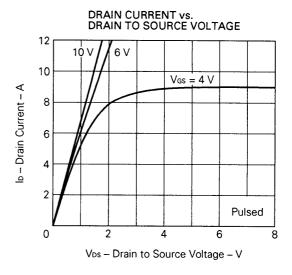
### TYPICAL CHARACTERISTICS (Ta = 25 °C)

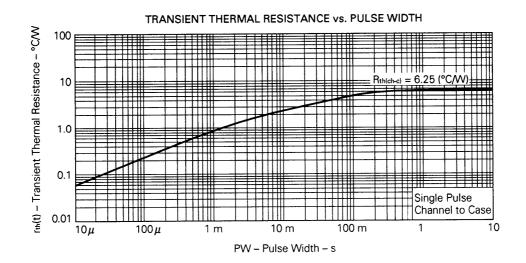




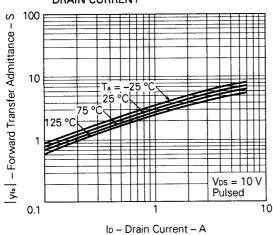


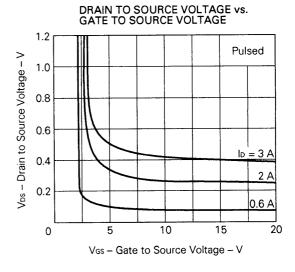


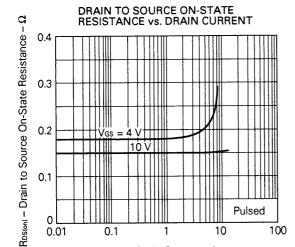




# FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT





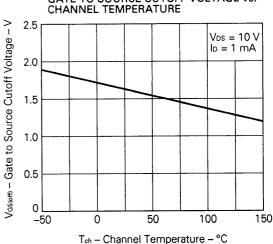


Ib - Drain Current - A

10

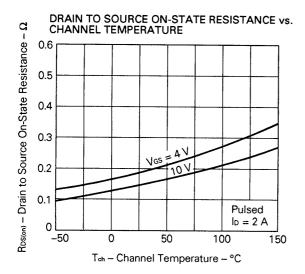
100

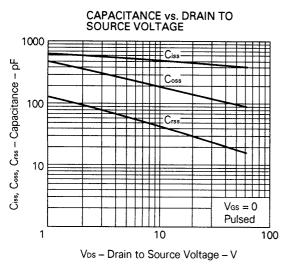
# GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

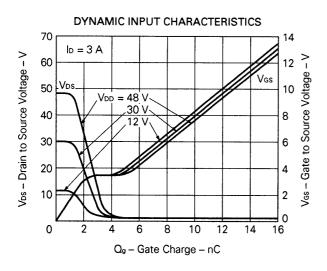


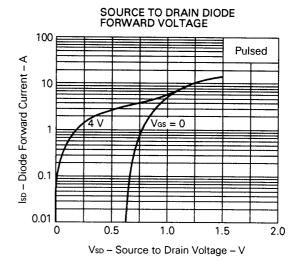
0.01

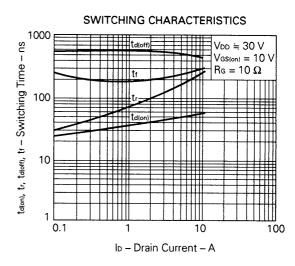
0.1

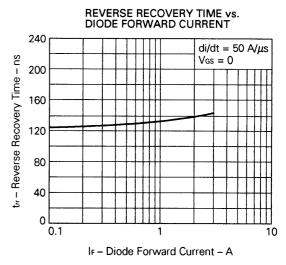












#### Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207

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